



Product Change Notification

Change Notification #: 116645 - 00
Change Title: Intel® Data Center Blocks for Cloud
MCB2208WFHY2, MCB2208WFAF4,
MCB2208WFAF5, MCB2208WFAF6,
PCN 116645-00, Product Design, Order Code,
Replacing select Intel SSD components
marked for end of life
Date of Publication: December 12, 2018

Key Characteristics of the Change:

Product Design, Order Code

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	January 10, 2019
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel Corporation is replacing Intel® SSD DC S3520 M.2, marked for end of life, with Intel® SSD D3 S4510 M.2 of equivalent capacity in select Intel® Data Center Blocks for Cloud MCB2208WFHY2, MCB2208WFAF4, MCB2208WFAF5 and MCB2208WFAF6.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the changes and determine the impact on their applications.

The date of "Customer Must be Ready to Receive Post-Conversion Material" is the projected date customers must be prepared to start receiving the Post-Converted Material. After this date, the Pre-Conversion SKUs will be discontinued and no longer guaranteed. They may be available only on a first come first serve basis, while supply lasts.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	Pre Change MM#	Post Change MM#
MCB2208WFAF6	9999P3	999DMA
MCB2208WFAF5	9999P8	999DMC
MCB2208WFAF4	9999P9	999DMD
MCB2208WFHY2	9999PA	999DMF

PCN Revision History:

Date of Revision:

December 12, 2018

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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